# EVERLIGHT ELECTRONICS CO., LTD.

# Technical Data Sheet Power Top View LED

#### Features

• P-LCC-3 package.

EVERLIGHT

- High flux output.
- High current capability.
- White package.
- Optical indicator.
- Colorless clear window.
- Ideal for backlight and light pipe application.
- Inter reflector.
- Wide viewing angle.
- Suitable for automatic placement equipment.
- Suitable for reflow and wave solder processes.
- Available on tape and reel (8mm Tape).
- Pb-free.
- The product itself will remain within RoHS compliant version.

#### **Descriptions**

The 67-31A series is available in soft orange, red and yellow. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector.

This feature makes the ideal for light pipe application. The low current requirement makes this device ideal for portable equipment or any other application where power is at a premium.

## Applications

- Indicator and backlight for audio and video equipment.
- Indicator and backlight in office and family equipment.
- Flat backlight for LCD's, switches and symbols.
- Light pipe application.
- General use.

#### **Device Selection Guide**

	Lens Color	
Material	<b>Emitted</b> Color	Lens Color
InGaN	Green	Water Clear

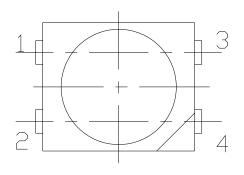
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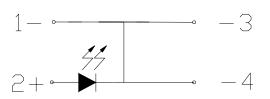


67-31A/GHC-YV1W2EZ3/2T



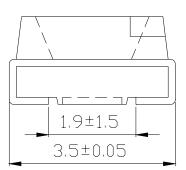
## **Package Dimensions**

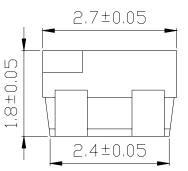


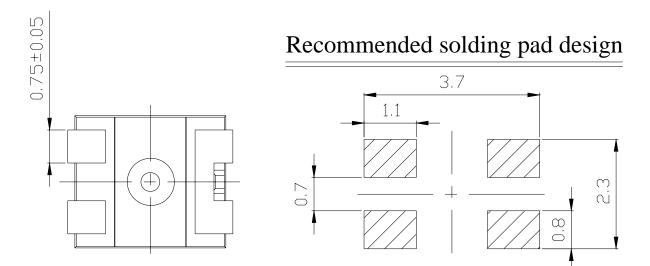


67-31A/GHC-YV1W2EZ3/2T

Polarity







Note: The tolerances unless mentioned is  $\pm 0.1$ mm; Unit = mm

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## <u>67-31A/GHC-YV1W2EZ3/2T</u>

## Absolute Maximum Ratings ( $T_A=25^{\circ}C$ )

Thosofute Muximum Rutings (TA=20 C)						
Parameter	Symbol	Rating	Unit			
Reverse Voltage	V <sub>R</sub>	5	V			
Forward Current	$I_{\rm F}$	30	mA			
Peak Forward Current (Duty 1/10 @1KHz)	IFP	100	mA			
Power Dissipation	Pd	110	mW			
Electrostatic Discharge(HBM)	ESD	150	V			
Operating Temperature	T <sub>opr</sub>	-40 ~ +85	°C			
Storage Temperature	T <sub>stg</sub>	-40 ~ +90	°C			
Soldering Temperature	Soldering TemperatureTsolReflow Soldering : 260 °C for 10 se Hand Soldering : 350 °C for 3 sec.					

### **Electronic Optical Characteristics :**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	$I_v$	715		1800	mcd	IF=30mA
Viewing Angle	2 heta 1/2		120		deg	IF=30mA
Peak Wavelength	λp		518		nm	IF=30mA
Dominant Wavelength	$\lambda_d$	520		535	nm	IF=30mA
Spectrum Radiation Bandwidth	$ riangle \lambda$		35		nm	IF=30mA
Forward Voltage	VF	2.75		3.65	V	IF=30mA
Reverse Current	I <sub>R</sub>			10	$\mu A$	V <sub>R</sub> =5V

#### Notes:

- 1.Tolerance of Luminous Intensity ±10%
- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.1V

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### **Bin Range Of Dominant Wavelengths**

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	Group	Bin Code	Min.	Max.	Unit	Condition
	Y	Х	520	525	nm	
		Y	525	530		IF=30mA
		Z	530	535		

#### **Bin Range Of Luminous Intensity**

Bin	Min	Max	Unit	Condition	
V1	715	900			
V2	900	1120	mad	IF=30mA	
W1	1120	1420	mcd		
W2	1420	1800			

#### **Bin Range Of Forward Voltage**

Group	Bin	Min	Max	Unit	Condition
Е	5	2.75	3.05		IF=30mA
	6	3.05	3.35	V	
	7	3.35	3.65		

#### Notes:

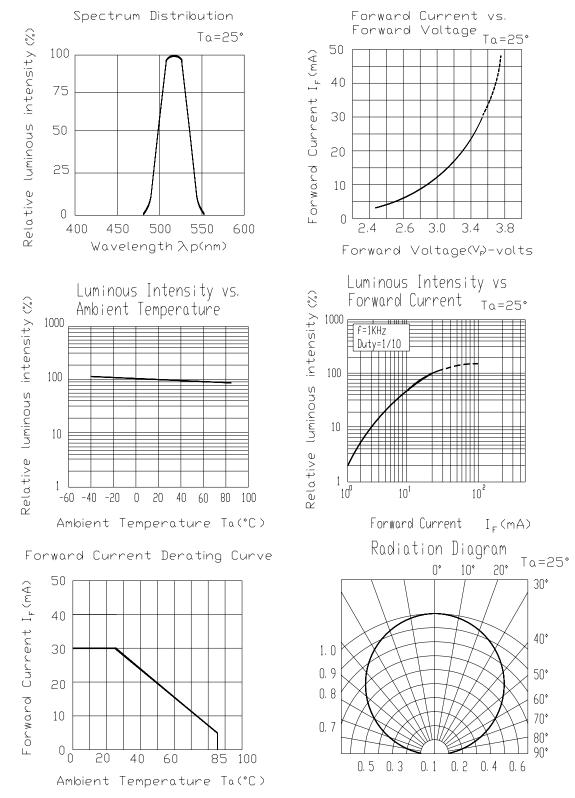
1.Tolerance of Luminous Intensity ±10%

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.1V



### **Typical Electro-Optical Characteristic Curves**



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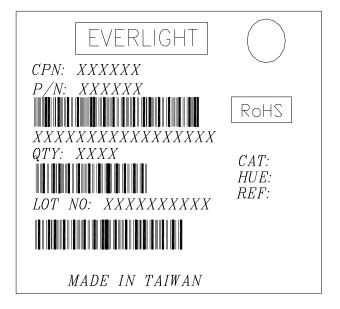


#### Label explanation

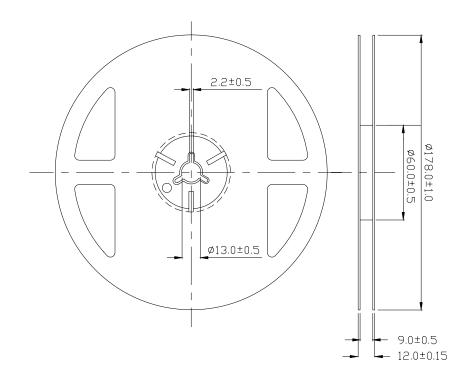
**CAT: Luminous Intensity Rank** 

HUE: Dom. Wavelength Rank

**REF: Forward Voltage Rank** 



#### **Reel Dimensions**

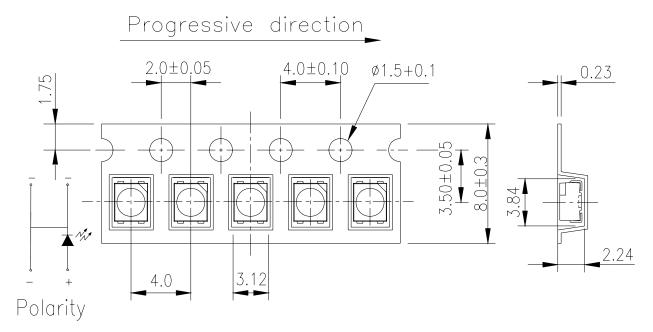


**Note:** The tolerances unless mentioned is  $\pm 0.1$  mm, Unit = mm

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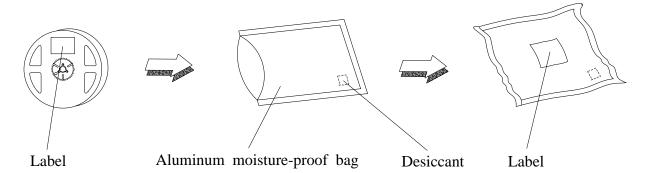


### Carrier Tape Dimensions; Loaded quantity per reel 2000 PCS/reel



**Note:** Tolerances Unless Dimension  $\pm 0.1$ mm Unit = mm

## **Moisture Resistant Packaging**



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### **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below. Confidence level : 90% LTPD : 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5 sec.	6 Min.	22 PCS	0/1
2	Temperature Cycle	H : +100°C 15min $\int 5 \text{ min}$ L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100°C 5min $\int 10 \sec L$ L: -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	<b>Temp.</b> : -40°℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_{F} = 30 \text{ mA} / 25^{\circ}C$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/85%RH	1000 Hrs.	22 PCS.	0/1

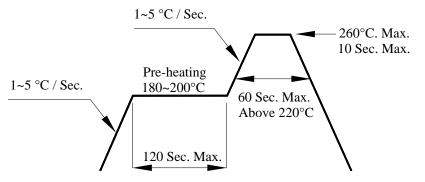


## **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change ( Burn out will happen ).

- 2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
  - 2.2 Before opening the package: The LEDs should be kept at  $30^{\circ}$ C or less and 90%RH or less.
  - 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
  - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
    Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
  - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

#### 4.Soldering Iron

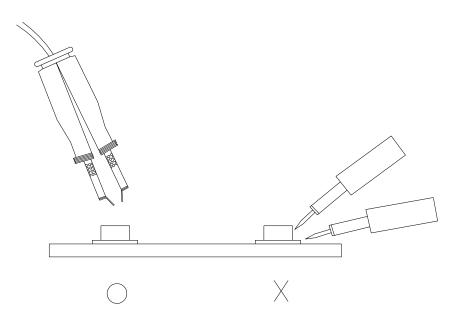
Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.



#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be

confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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